## SN5426, SN54LS26, SN7426, SN74LS26 QUADRUPLE 2-INPUT

**SDLS087** 

HIGH-VOLTAGE INTERFACE POSITIVE-NAND GATES DECEMBER 1983-REVISED MARCH 1988

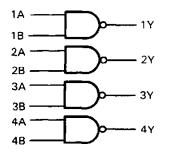
 For Driving Low-Threshold-Voltage MOS Inputs

## description

These 2-input open-collector NAND gates feature high-output voltage ratings for interfacing with low-threshold-voltage MOS logic circuits or other 12-volt systems. Although the output is rated to withstand 15 volts, the V<sub>CC</sub> terminal is connected to the standard 5-volt source.

The SN5426 and SN54LS26 are characterized for operation over the full military temperature range of -55 °C to 125 °C. The SN7426 and SN74LS26 are characterized for operation from 0 °C to 70 °C.

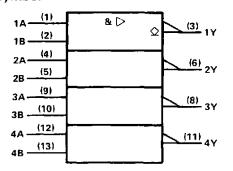
#### logic diagram



positive logic

 $Y = \overline{AB}$ 

logic symbol<sup>†</sup>

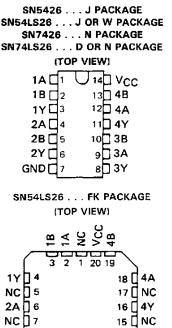


<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.





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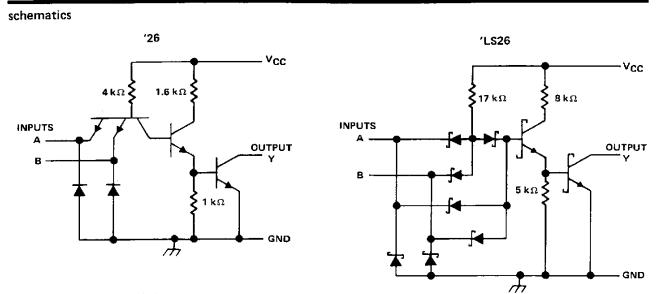
NC - No internal connection

68

14 🛛 3B

28 8

## SN5426, SN54LS26, SNSN7426, SN74LS26 QUADRUPLE 2-INPUT HIGH-VOLTAGE INTERFACE POSITIVE-NAND GATES



Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

	2 1)	
Input voltage: '26		. 5.5 V
Operating free-air temperature:	: SN54′	to 125°C
	SN74′0°C	to 70°C
Storage temperature range		to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.



## SN54LS26, SN74LS26 QUADRUPLE 2-INPUT HIGH-VOLTAGE INTERFACE POSITIVE-NAND GATES

#### recommended operating conditions

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	s	SN54LS26			SN74LS26		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V <sub>CC</sub> Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH High-level input voltage	2			2			V
VIL Low-level input voltage			0.7			0.8	V
VOH High-level output voltage			15			15	V
OL Low-level output current			4			8	mA
TA Operating free-air temperature	- 55		125	0		70	°C

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEET CONDU	S	N54LS	26	SN74LS26				
PANAMETER		TEST CONDITIONS <sup>†</sup>			TYP‡	MAX	MIN	TYP‡	MAX	
VIK	V <sub>CC</sub> = MIN,	l <sub>l</sub> = 18 mA				- 1.5			- 1.5	V
1-	V <sub>CC</sub> = MIN,	VIL = MAX,	V <sub>OH</sub> = 12 V			50			50	μA
юн	V <sub>CC</sub> = MIN,	VIL = MAX,	V <sub>OH</sub> = 15 V			1			1	mA
17	V <sub>CC</sub> = MIN,	V <sub>1H</sub> = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	
VOL	V <sub>CC</sub> = MIN,	V <sub>1H</sub> ≈ 2 V,	IOL = 8 mA					0.35	0.5	V
1	V <sub>CC</sub> = MAX,	V1 = 7 V	·····			0.1			0.1	mΑ
ЧН	V <sub>CC</sub> = MAX,	V <sub>IH</sub> = 2.7 V				20			20	μA
<sup>4</sup> IL	V <sub>CC</sub> = MAX,	V <sub>IL</sub> = 0.4 V	····			- 0.4			- 0.4	mA
ІССН	V <sub>CC</sub> = MAX,	V   = 0			0.8	1.6		0.8	1.6	mA
CCL	V <sub>CC</sub> = MAX,	V   = 4.5 V			2.4	4.4		2,4	4.4	

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

switching characteristics,  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$  (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		YP MAX	UNIT
	A or B	Y	$R_L = 2 k\Omega$ , $C_L = 15 pF$	<u> </u>	17 32	ns
<sup>t</sup> ₽HL					15 28	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



## SN5426, SN7426 QUADRUPLE 2-INPUT HIGH-VOLTAGE INTERFACE POSITIVE NAND GATES

#### recommended operating conditions

		SN5426		SN7426			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
VCC Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH High-level input voltage	2			2			v
VIL Low-level input voltage			0.8			0.8	v
VOH High-level output voltage			15			15	V
IOL Low-level output current			16			16	mΑ
T <sub>A</sub> Operating free-air temperature	- 55		125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONDITIONS <sup>†</sup>	SN5426	SN7426	
PARAMETER		MIN TYP <sup>‡</sup> MAX	MIN TYP <sup>‡</sup> MAX	UNIT
VIK	$V_{CC} = MIN,  I_{I} \approx -12 \text{ mA}$	- 1.5	1.5	V
	$V_{CC} = MIN, V_{IL} = 0.8 V, V_{OH} = 12 V$		50	
la	$V_{CC} = MIN, V_{IL} = 0.7 V, V_{OH} = 12 V$	50		μA
юн	$V_{CC} = MIN, V_{IL} = 0.8 V, V_{OH} = 15 V$		1	4
	$V_{CC} = MIN, V_{IL} = 0.7 V, V_{OH} = 15 V$	1		mA
VOL	$V_{CC} = MIN$ , $V_{IH} = 2V$ , $I_{OL} = 16 mA$	0.4	0.4	V
lj –	$V_{CC} = MAX$ , $V_I = 5.5 V$	1	1	mA
ін	$V_{CC} = MAX, V_l = 2.4 V$	40	40	μA
	$V_{CC} = MAX, V_I = 0.4 V$	- 1.6	-1.6	mΑ
ССН	$V_{CC} = MAX,  V_{I} = 0$	4 8	4 8	mA
ICCL	$V_{CC} = MAX, V_I = 4.5 V$	12 22	12 22	mΑ

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25 °$ C.

## switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$ (see note 2)

PARAMETER	FROM (INPUT)	TQ (OUTPUT)	TEST CONDI	TIONS	MIN	түр	MAX	UNIT
tPLH	A or B	×	Řι = 1 kΩ,	C <sub>1</sub> = 15 pF		16	24	ns
<sup>T</sup> PHL		•		с <u>Г - тэр</u> ь		11	17	ńs

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

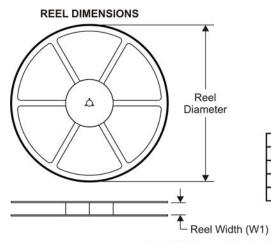


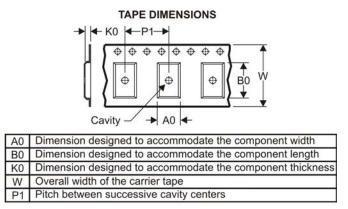
## PACKAGE MATERIALS INFORMATION

www.ti.com

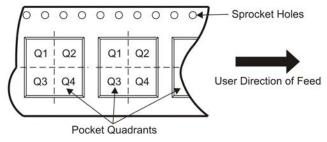
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## TAPE AND REEL INFORMATION





### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal	
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Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS26DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1

TEXAS INSTRUMENTS

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## PACKAGE MATERIALS INFORMATION

29-Jul-2009



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS26DR	SOIC	D	14	2500	346.0	346.0	33.0

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